DATA SHEET



MOS FIELD EFFECT TRANSISTOR **2SK2484**

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2484 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

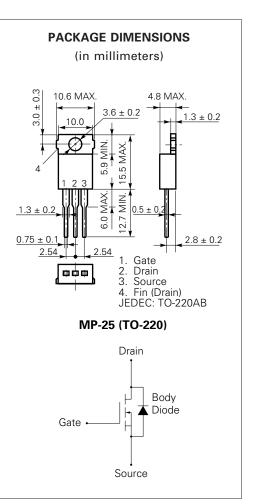
FEATURES

- Low On-Resistance
- $R_{DS(on)} = 2.8 \ \Omega \ (V_{GS} = 10 \ V, \ I_{D} = 3.0 \ A)$
- Low C_{iss} $C_{iss} = 1 200 \text{ pF TYP}.$
- High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	Vdss	900	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	D(DC)	±5.0	А
Drain Current (pulse)*	D(pulse)	±10	А
Total Power Dissipation (T _c = 25 $^{\circ}$ C)	Рт1	75	W
Total Power Dissipation (T _A = 25 $^{\circ}$ C)	Рт2	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current**	las	5.0	А
Single Avalanche Energy**	Eas	75	mJ
* PW \leq 10 μ s, Duty Cycle \leq 1 %			
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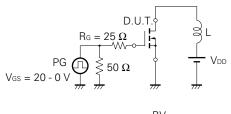


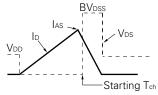


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

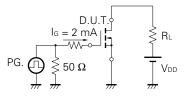
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-State Resistance	RDS(on)		2.2	2.8	Ω	$V_{GS} = 10 \text{ V}, \text{ Id} = 3.0 \text{ A}$
Gate to Source Cutoff Voltage	V _{GS(off)}	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	y _{fs}	2.0			S	$V_{DS} = 20 V, I_{D} = 3.0 A$
Drain Leakage Current	Ibss			100	μA	Vds = Vdss, Vgs = 0
Gate to Source Leakage Current	lgss			±100	nA	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0$
Input Capacitance	Ciss		1 200		pF	$V_{DS} = 10 V$
Output Capacitance	Coss		170		pF	V _{GS} = 0
Reverse Transfer Capacitance	Crss		30		pF	f = 1 MHz
Turn-On Delay Time	td(on)		20		ns	ID = 3.0 A
Rise Time	tr		10		ns	$V_{GS} = 10 V$
Turn-Off Delay Time	td(off)		70		ns	$V_{DD} = 150 V$
Fall Time	tf		15		ns	$R_G = 10 \ \Omega$
Total Gate Charge	QG		40		nC	ID = 5.0 A
Gate to Source Charge	Qgs		7		nC	$V_{DD} = 450 V$
Gate to Drain Charge	Qgd		17		nC	Vgs = 10 V
Body Diode Forward Voltage	V _{F(S-D)}		1.0		V	IF = 5.0 A, VGS = 0
Reverse Recovery Time	trr		670		ns	IF = 5.0 A, VGS = 0
Reverse Recovery Charge	Qrr		3.5		μC	di/dt = 50 A/ μ s

Test Circuit 1 Avalanche Capability

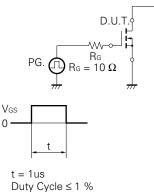


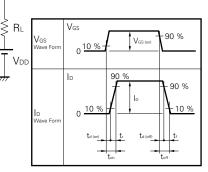


Test Circuit 3 Gate Charge

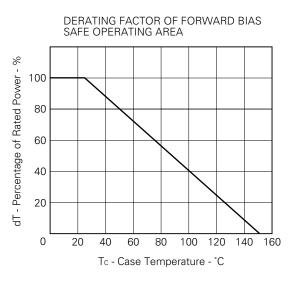


Test Circuit 2 Switching Time

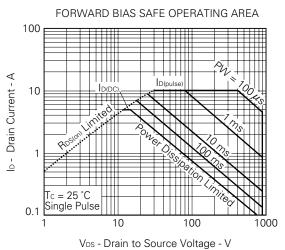




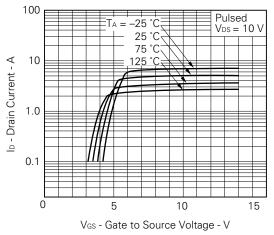
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

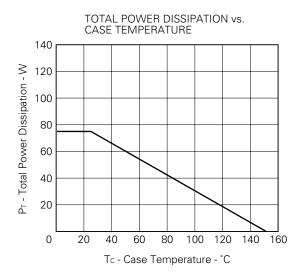




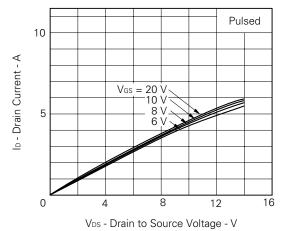


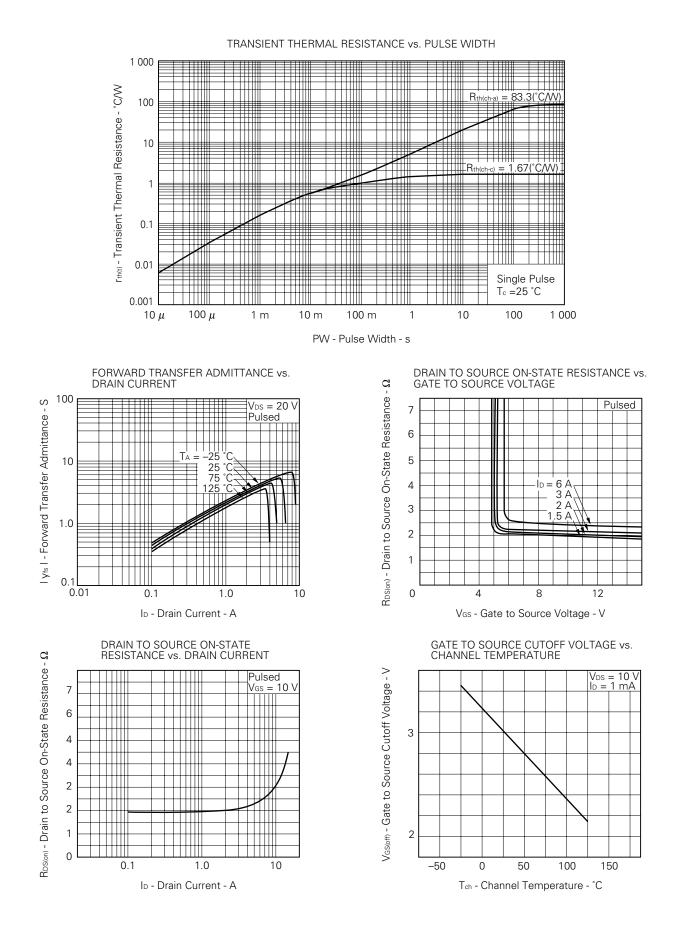


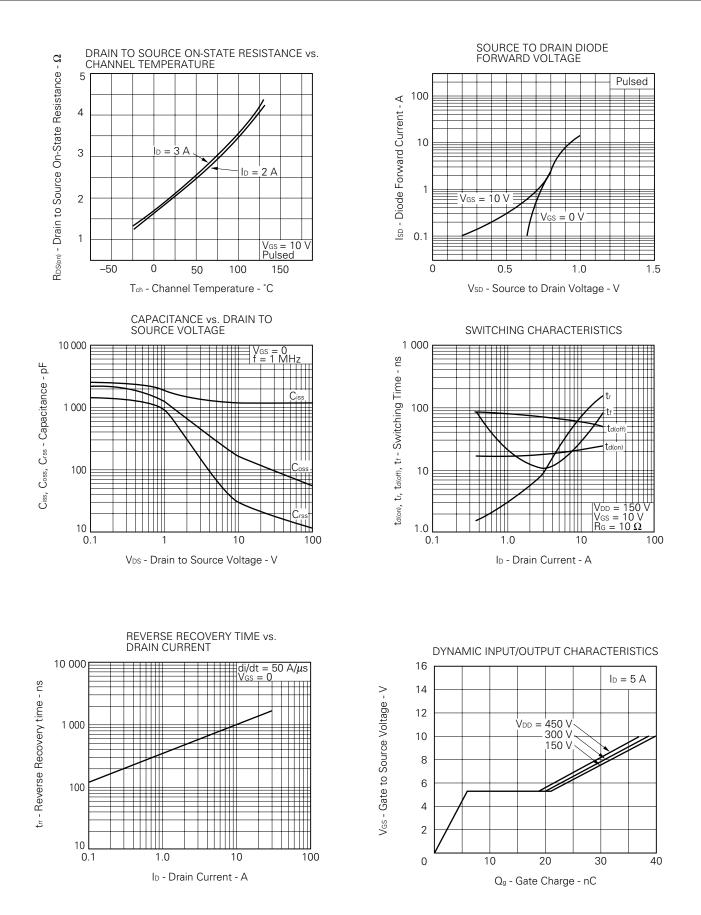


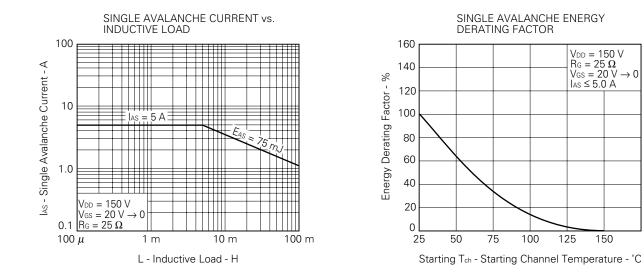












REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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Anti-radioactive design is not implemented in this product.